

60V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = 25℃	
60)/	$40m\Omega @ V_{GS} = 10V$	5.0A	
60V	$55 \mathrm{m}\Omega @ \mathrm{V}_{\mathrm{GS}} = 4.5 \mathrm{V}$	4.4A	

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

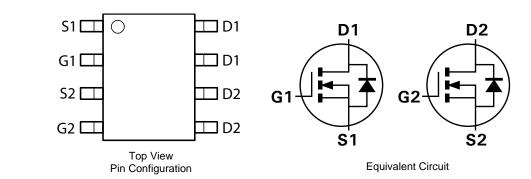
- DC-DC Converters
- Power management functions
- Backlighting

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN6040SSD-13	SO-8	2,500/Tape & Reel

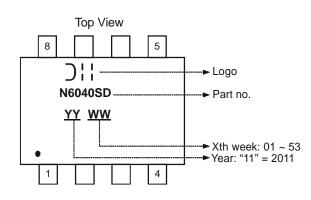
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings $@T_A = 25$ °C unless otherwise specified

Characteristic Drain-Source Voltage Gate-Source Voltage			Symbol	Value	Units V V
			V _{DSS}	60	
			V _{GSS}	±20	
	Steady State	T _A = 25℃ T _A = 70℃	ID	5.0 4.1	А
Continuous Drain Current (Note 6) $V_{GS} = 10V$	t<10s	T _A = 25℃ T _A = 70℃	ID	6.6 5.3	А
Maximum Body Diode Forward Current (Note 6)			Is	2.5	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	30	A
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	14.2	А
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	10	mJ

Thermal Characteristics $@T_A = 25$ °C unless otherwise specified

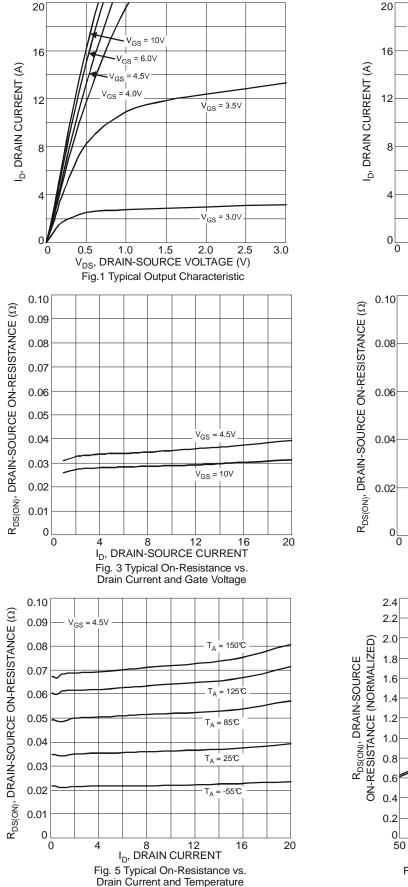
Characteristic	Symbol	Value	Units	
Total Bower Dissinction (Note E)	T _A = 25℃	Р	1.3	W
Total Power Dissipation (Note 5)	T _A = 70℃	PD	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Р	102	C/W
	t<10s	$R_{ heta JA}$	61	
Total Dower Dissinction (Note 6)	T _A = 25℃	Р	1.7	w
Total Power Dissipation (Note 6)	T _A = 70℃	PD	1.1	
Thermal Desistance, lunction to Ambient (Nate C)	Steady state	P	75	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ heta}JA$	50	
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	14.5	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	C

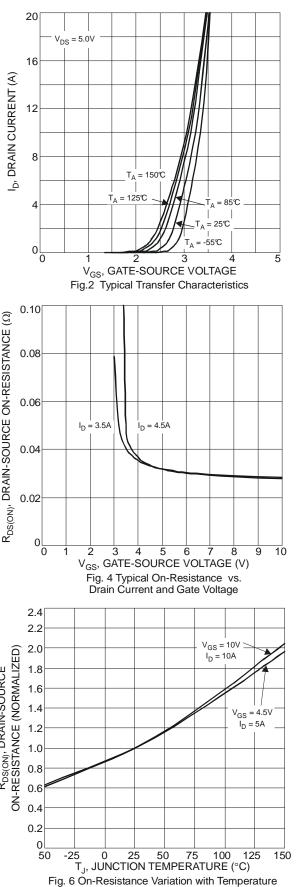
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Tun	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	Тур	WidX	Unit	Test condition	
Drain-Source Breakdown Voltage	D\/	60	<u> </u>		V		
	BV _{DSS}			100	nA	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_			$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1		3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	RDS (ON)	_	30	40	mΩ	$V_{GS} = 10V, I_D = 4.5A$	
	NDS (ON)		35	55	1115.2	$V_{GS} = 4.5V, I_D = 3.5A$	
Forward Transfer Admittance	Y _{fs}		4.5		S	$V_{DS} = 10V, I_D = 4.3A$	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1287	_			
Output Capacitance	C _{oss}	_	57		pF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		44				
Gate Resistance	R _G	_	1.2		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qq		22.4				
Total Gate Charge (V _{GS} = 4.5V)	Qg		10.4		nC	$V_{DS} = 30V, I_D = 4.3A$	
Gate-Source Charge	Q _{gs}	_	4.9	_	nc		
Gate-Drain Charge	Q _{gd}	_	3.0				
Turn-On Delay Time	t _{D(on)}	_	6.6				
Turn-On Rise Time	tr	_	8.1			$\label{eq:VGS} \begin{split} V_{GS} = 10V, \ V_{DD} = 30V, \ R_G = 6\Omega, \\ I_D = 4.3A \end{split}$	
Turn-Off Delay Time	t _{D(off)}		20.1		nS		
Turn-Off Fall Time	t _f		4.0				
Body Diode Reverse Recovery Time	t _{rr}		18		nS	I _S = 4.3A, dl/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{rr}	_	11.9	_	nC	I _S = 4.3A, dl/dt = 100A/µs	

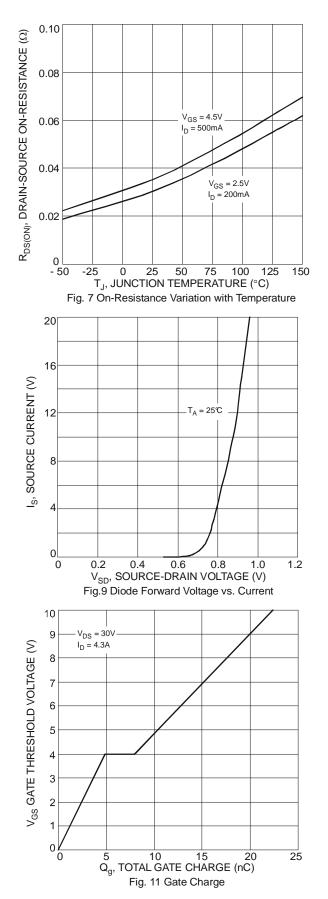
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep $T_J = 25^{\circ}$ 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:

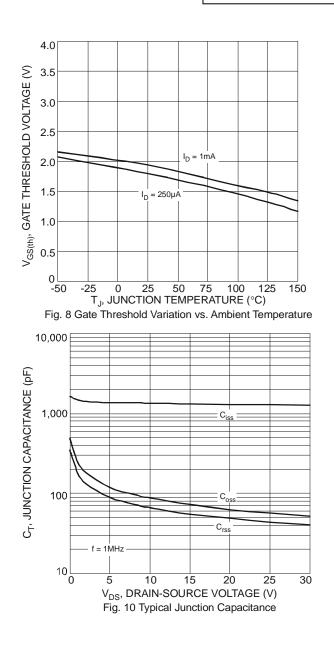






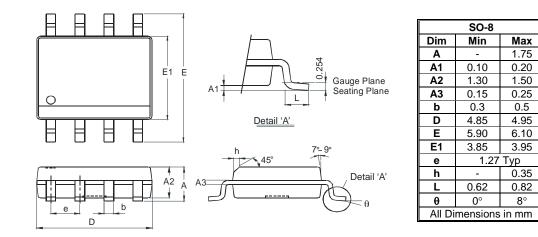




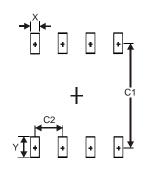




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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